

Multilayer Ceramic Chip Capacitors

CGA9N3X7R2E105M230KE



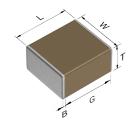






TDK item description CGA9N3X7R2E105MT***S

Applications	Automotive Grade
	AEC-Q200 AEC-Q200
Feature	Mid Woltage (100 to 630V)
	Soft Termination
Series	CGA9(5750) [EIA 2220]
Status	Production
Brand	TDK



Size	
Length(L)	5.70mm +0.50,-0.40mm
Width(W)	5.00mm ±0.40mm
Thickness(T)	2.30mm +0.30,-0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	
Recommended Land Pattern (PA)	4.10mm to 4.80mm
Recommended Land Pattern (PB)	1.20mm to 1.40mm
Recommended Land Pattern (PC)	4.00mm to 5.00mm

Electrical Characteristics		
Capacitance	1μF ±20%	
Rated Voltage	250VDC	
Temperature Characteristic	X7R(±15%)	
Dissipation Factor (Max.)	3%	
Insulation Resistance (Min.)	500ΜΩ	

	Other
Operating Temp. Range	-55 to 125°C
Soldering Method	Reflow
AEC-Q200	YES
Packing	Embossed (Plastic)Taping [180mm Reel]
Package Quantity	500pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

 $^{! \ \}mbox{All specifications}$ are subject to change without notice.

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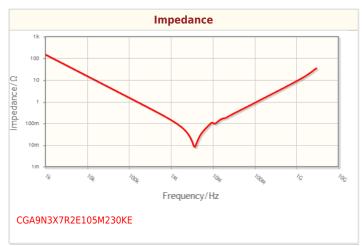


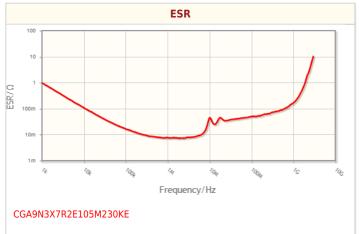


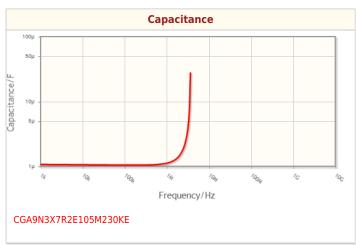




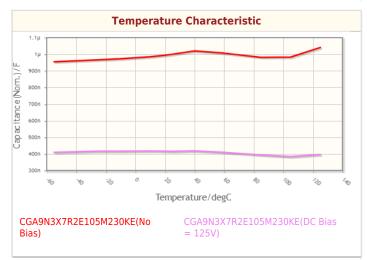
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

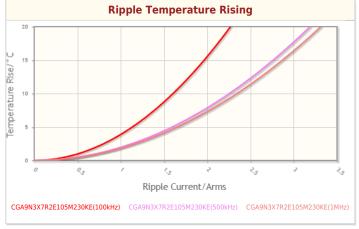












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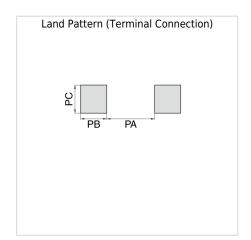








Associated Images



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